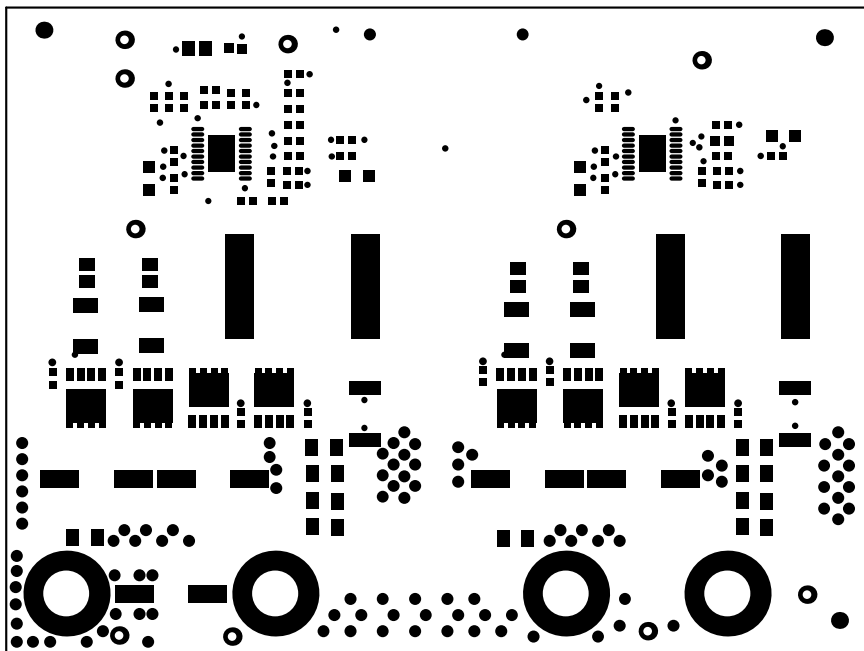
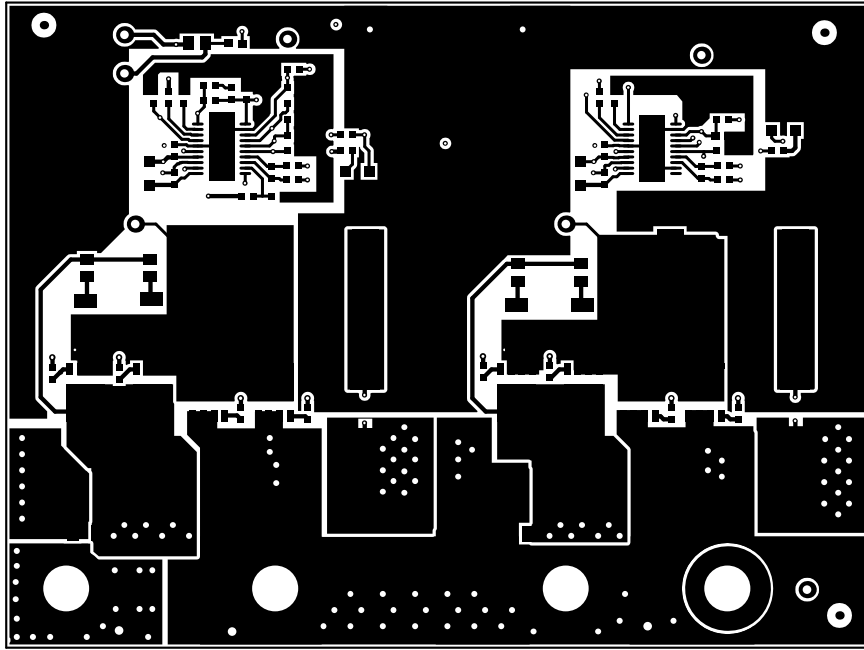


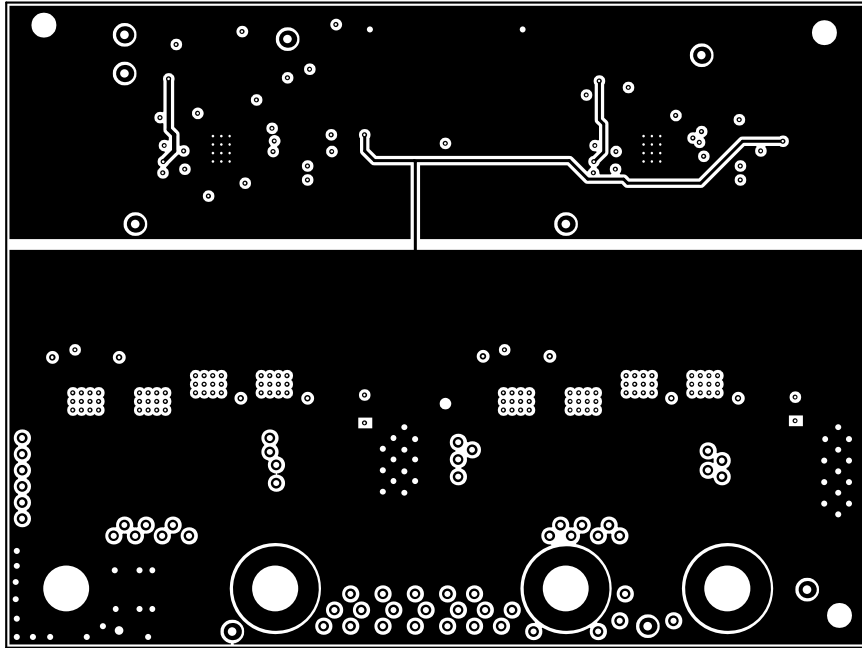
ALL ARTWORK VIEWED FROM TOP SIDE	PROJECT NAME = PMP7850 REV B	
LAYER NAME = Top Overlay	ARTWORK # = 880XX7850-001 REV B	TEXAS INSTRUMENTS
PLOT NAME = Top Overlay	GENERATED : 4/10/2015	5:46:04 PM



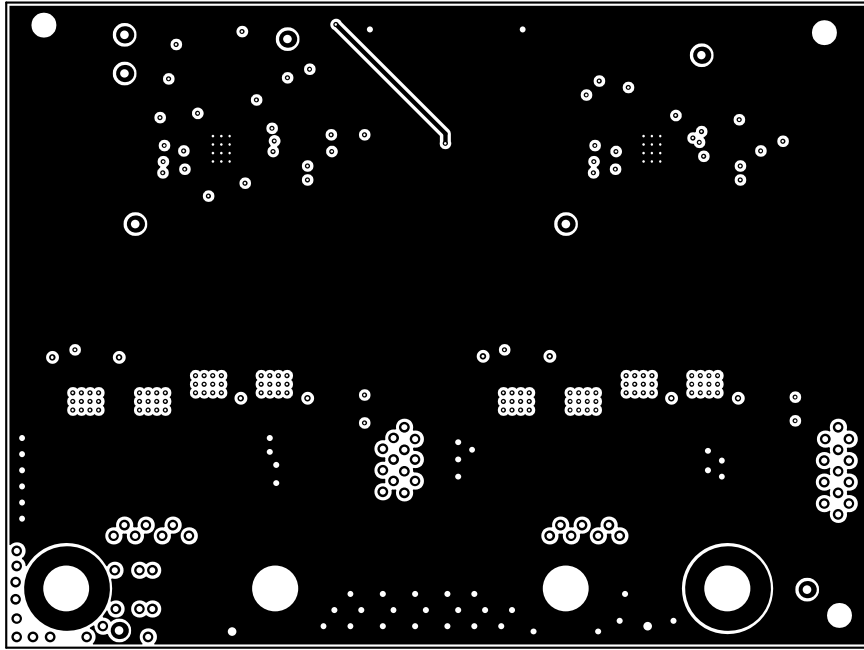
ALL ARTWORK VIEWED FROM TOP SIDE	PROJECT NAME = PMP7850 REV B	
LAYER NAME = Top Solder	ARTWORK # = 880XX7850-001 REV B	TEXAS INSTRUMENTS
PLOT NAME = Top Solder Mask	GENERATED	: 4/10/2015 5:46:04 PM



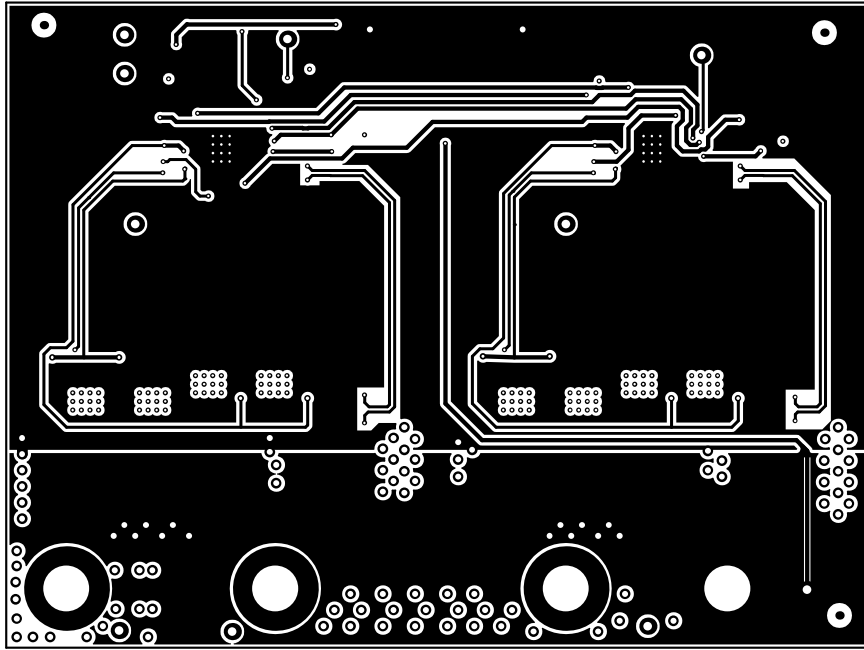
ALL ARTWORK VIEWED FROM TOP SIDE	PROJECT NAME = PMP7850 REV B	
LAYER NAME = Top Layer	ARTWORK # = 880XX7850-001 REV B	TEXAS INSTRUMENTS
PLOT NAME = Top Layer	GENERATED	: 4/10/2015 5:46:05 PM



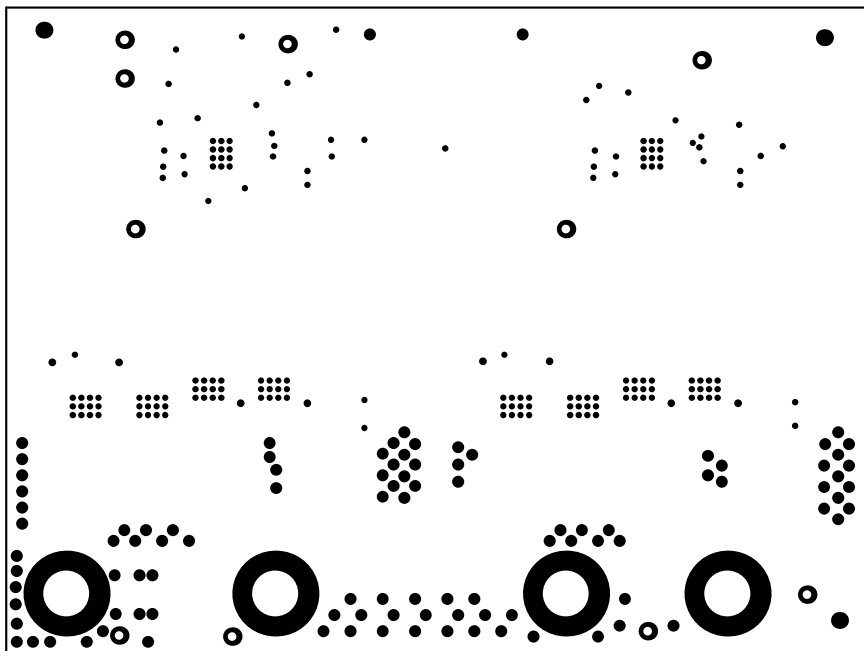
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LAYER NAME = M1 Board Outline	ARTWORK # = 880XX7850-001 REV B	TEXAS INSTRUMENTS
PLOT NAME = MidLayer 1	GENERATED	: 4/10/2015 5:46:05 PM



ALL ARTWORK VIEWED FROM TOP SIDE	PROJECT NAME = PMP7850 REV B	
LAYER NAME = M1 Board Outline	ARTWORK # = 880XX7850-001 REV B	TEXAS INSTRUMENTS
PLOT NAME = Midlayer 2	GENERATED : 4/10/2015 5:46:05 PM	



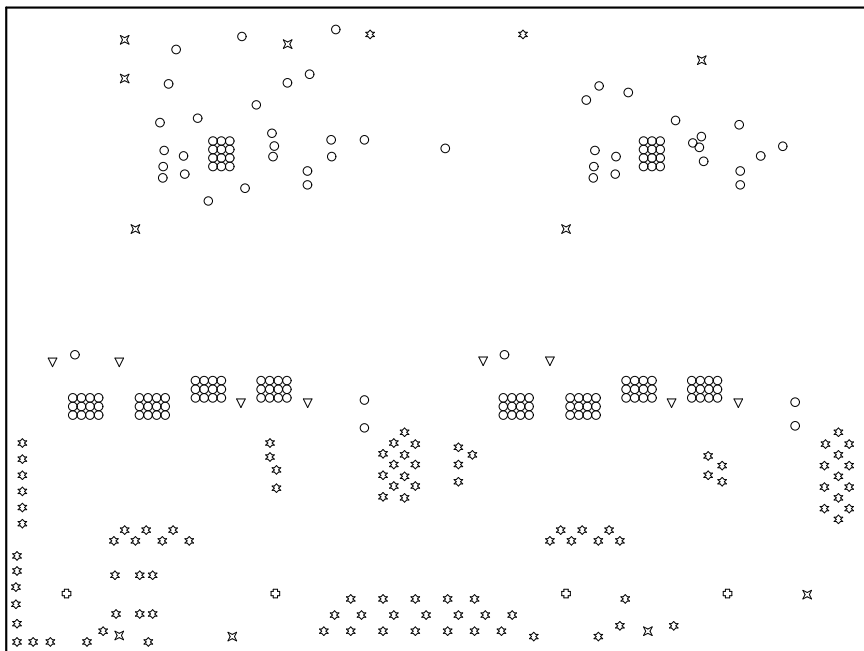
ALL ARTWORK VIEWED FROM TOP SIDE	PROJECT NAME = PMP7850 REV B	
LAYER NAME = Bottom Layer	ARTWORK # = 880XX7850-001 REV B	TEXAS INSTRUMENTS
PLOT NAME = Bottom Layer	GENERATED	: 4/10/2015 5:46:06 PM



ALL ARTWORK VIEWED FROM TOP SIDE	PROJECT NAME = PMP7850 REV B	
LAYER NAME = Bottom Solder	ARTWORK # = 880XX7850-001 REV B	TEXAS INSTRUMENTS
PLOT NAME = Bottom Solder Mask	GENERATED : 4/10/2015 5:46:06 PM	

UL34U-0 MADE IN U.S.
881XX7850-001 REV B

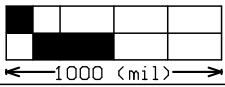
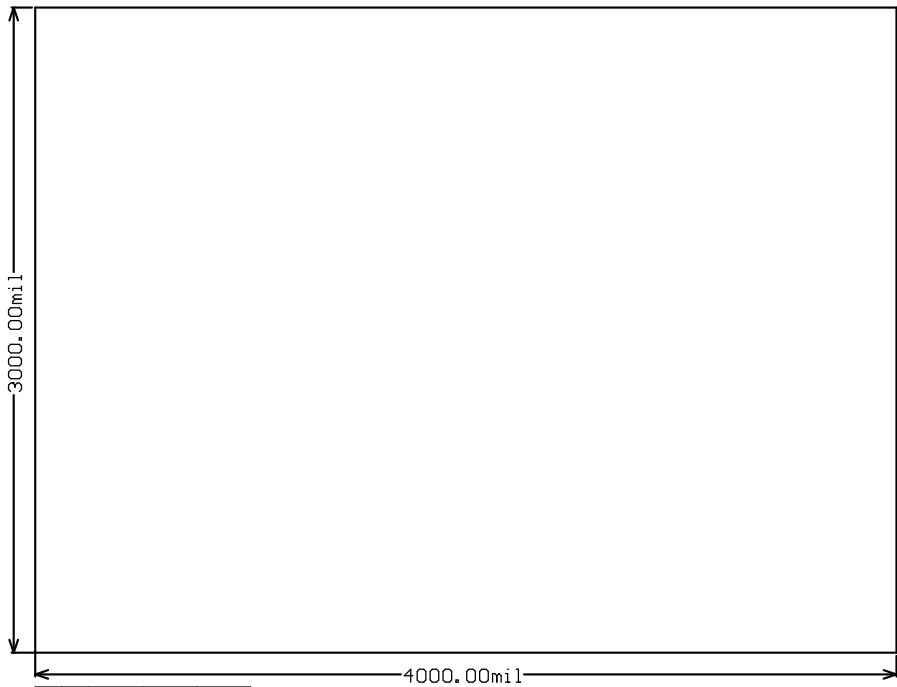
ALL ARTWORK VIEWED FROM TOP SIDE	PROJECT NAME = PMP7850 REV B	
LAYER NAME = Bottom Overlay	ARTWORK # = 880XX7850-001 REV B	TEXAS INSTRUMENTS
PLOT NAME = Bottom Overlay	GENERATED : 4/10/2015 5:46:07 PM	



Symbol	Hit Count	Tool Size	Plated	Hole Type
○	169	12mil (0.305mm)	PTH	Round
▽	8	15mil (0.381mm)	PTH	Round
☆	101	28mil (0.711mm)	PTH	Round
✕	10	40mil (1.016mm)	PTH	Round
⊕	4	214.567mil (5.45mm)	PTH	Round
292 Total				

Drill Table

ALL ARTWORK VIEWED FROM TOP SIDE	PROJECT NAME = PMP7850 REV B	
LAYER NAME = Drill Drawing	ARTWORK # = 880XX7850-001 REV B	TEXAS INSTRUMENTS
PLOT NAME = Drill Drawing	GENERATED : 4/10/2015 5:46:07 PM	



ALL ARTWORK VIEWED FROM TOP SIDE	PROJECT NAME = PMP7850 REV B	
LAYER NAME = M2 Board Dimensions	ARTWORK # = 880XX7850-001 REV B	TEXAS INSTRUMENTS
PLOT NAME = Board Dimensions	GENERATED	: 4/10/2015 5:46:07 PM

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